RU140N10R

N-Channel Advanced Power MOSFET

Features

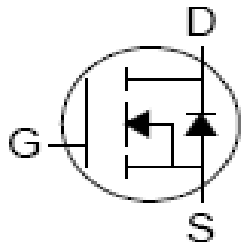
- 100V/140A
  $R_{DS\ (ON)}$=6.5mΩ(Typ.) @ V_{GS}=10V
- Ultra Low On-Resistance
- Low Gate Charge
- Fast Switching and Fully Avalanche Rated
- 100% avalanche tested

Applications

- Switching applications

Pin Description

TO-220



N-Channel MOSFET

Absolute Maximum Ratings

Symbol	Parameter		Rating	Unit
Common Ratings (T_A=25°C Unless Otherwise Noted)				
V_{DSS}	Drain-Source Voltage		100	V
V_{GSS}	Gate-Source Voltage		±25	
T_J	Maximum Junction Temperature		175	°C
T_{STG}	Storage Temperature Range		-55 to 175	°C
I_S	Diode Continuous Forward Current	T_C=25°C	140①	A
Mounted on Large Heat Sink				
I_{DP}	300μs Pulsed Drain Current Tested	T_C=25°C	560②	A
I_D	Continue Drain Current	T_C=25°C	140①	
		T_C=100°C	100①	
P_D	Maximum Power Dissipation	T_C=25°C	250	W
		T_C=100°C	125	
$R_{\theta JC}$	Thermal Resistance -Junction to Case		0.6	°C/W
Drain-Source Avalanche Ratings				
E_{AS}③	Avalanche Energy ,Single Pulsed		1.1	J

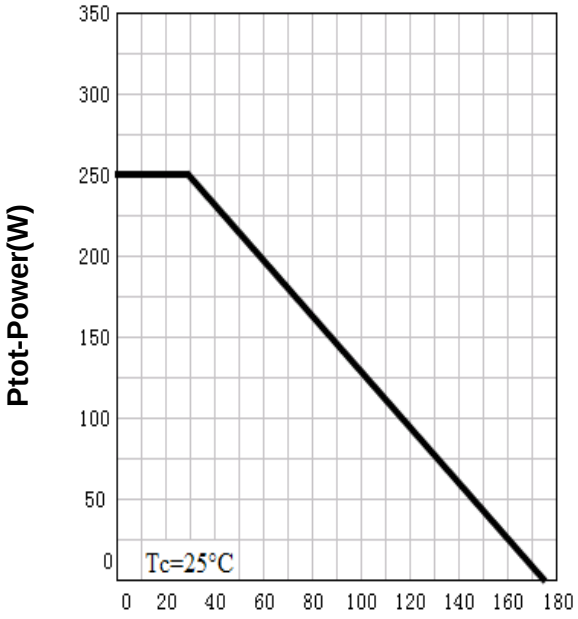
Electrical Characteristics (T_A=25°C Unless Otherwise Noted)

Symbol	Parameter	Test Condition	RU140N10R			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_{DS}=250μA	100			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}= 100V, V_{GS}=0V			1	μA
		T_J=85°C			30	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_{DS}=250μA	2	3	4	V
I_{GSS}	Gate Leakage Current	V_{GS}=±25V, V_{DS}=0V			±100	nA
$R_{DS(ON)}$ ④	Drain-Source On-state Resistance	V_{GS}= 10V, I_{DS}=40A		6.5	8	mΩ
Diode Characteristics						
V_{SD} ④	Diode Forward Voltage	I_{SD}=40 A, V_{GS}=0V			1.2	V
t_{rr}	Reverse Recovery Time	I_{SD}=40A, dI_{SD}/dt=100A/μs		90		ns
q_{rr}	Reverse Recovery Charge			200		nC
Dynamic Characteristics ⑤						
R_G	Gate Resistance	V_{GS}=0V,V_{DS}=0V,F=1MHz		1.6		Ω
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}= 25V, Frequency=1.0MHz		7550		pF
C_{oss}	Output Capacitance			810		
C_{rss}	Reverse Transfer Capacitance			250		
$t_{d(ON)}$	Turn-on Delay Time	V_{DD}=50V,I_{DS}= 70A, V_{GEN}= 10V,R_G=2.5Ω		30		ns
t_r	Turn-on Rise Time			210		
$t_{d(OFF)}$	Turn-off Delay Time			160		
t_f	Turn-off Fall Time			120		
Gate Charge Characteristics ⑤						
Q_g	Total Gate Charge	V_{DS}=80V, V_{GS}= 10V, I_{DS}=70A		135		nC
Q_{gs}	Gate-Source Charge			30		
Q_{gd}	Gate-Drain Charge			45		

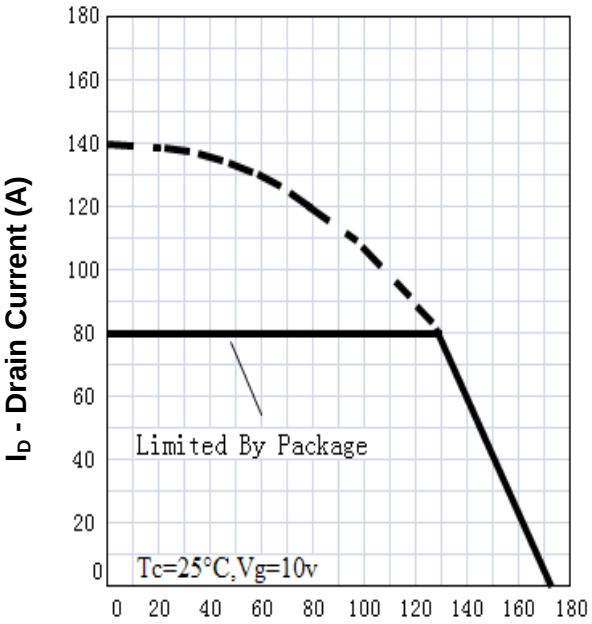
Notes: ①Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.
②Pulse width limited by safe operating area.
③Limited by T_{Jmax},I_{AS} =55A, V_{DD} = 50V, R_G = 47Ω , Starting T_J = 25°C.
④Pulse test ; Pulse width≤400μs, duty cycle≤2%.
⑤Guaranteed by design, not subject to production testing.

Typical Characteristics

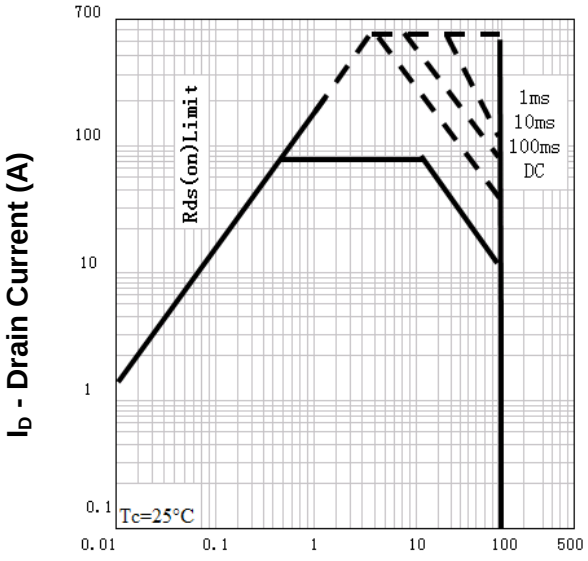
Power Dissipation



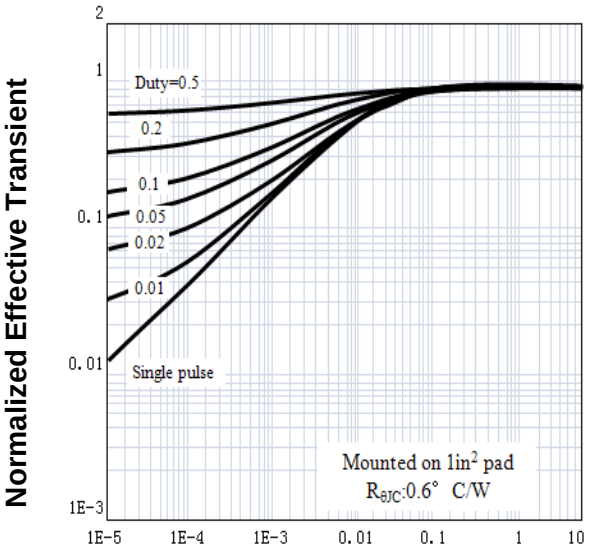
Drain Current



Safe Operation Area

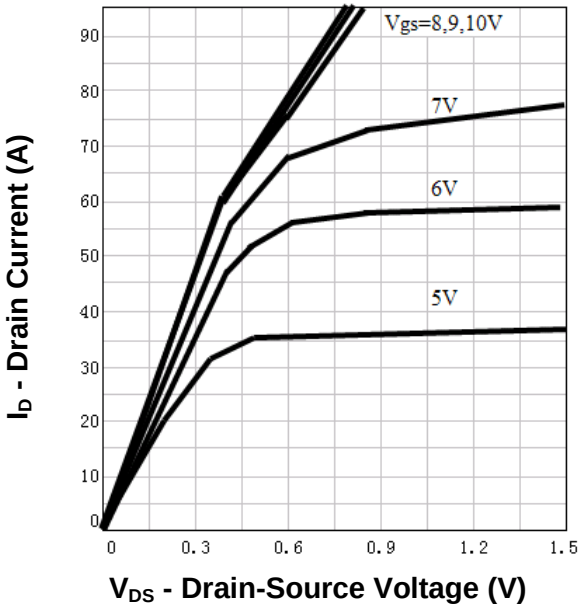


Thermal Transient Impedance

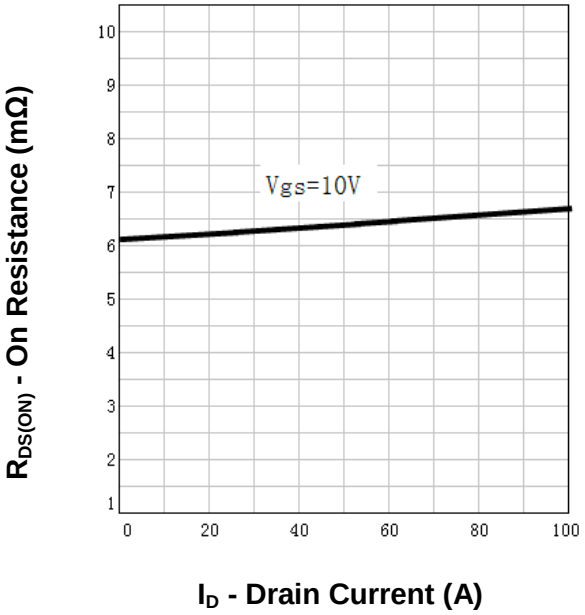


Typical Characteristics

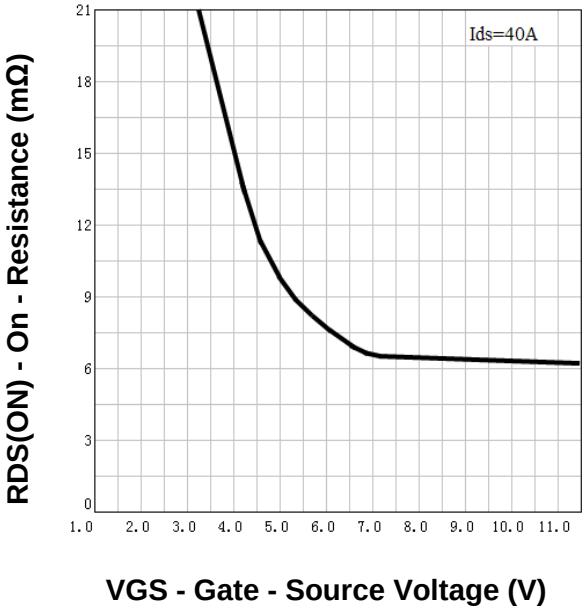
Output Characteristics



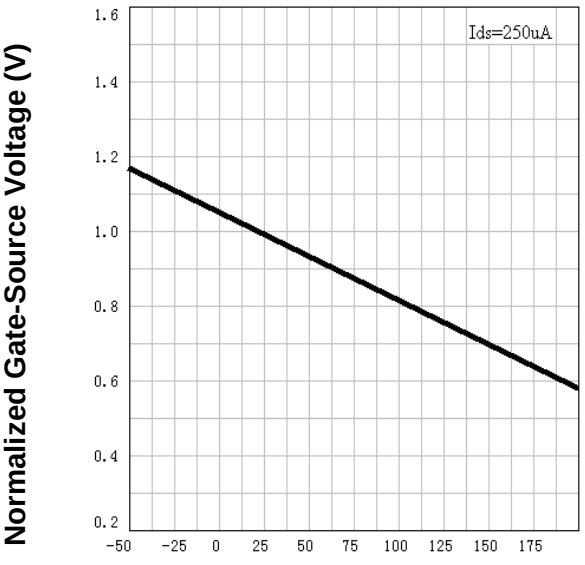
Drain-Source On Resistance



Drain-Source On Resistance

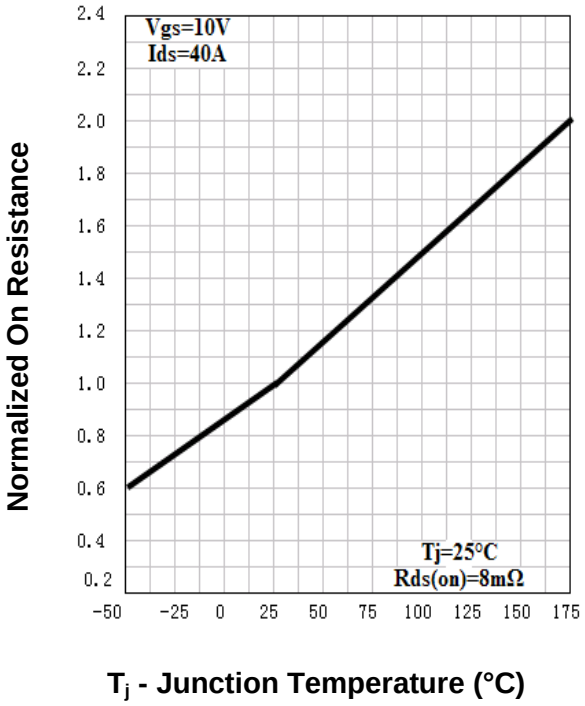


Normalized Gate Threshold Voltage



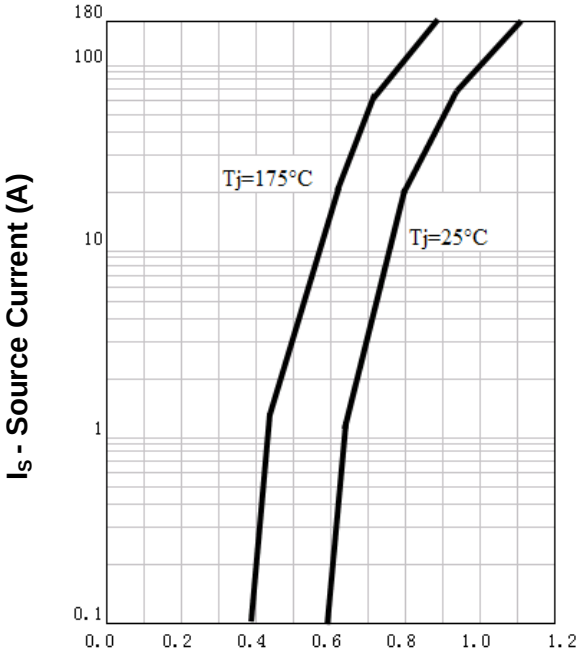
Typical Characteristics

Drain-Source On Resistance



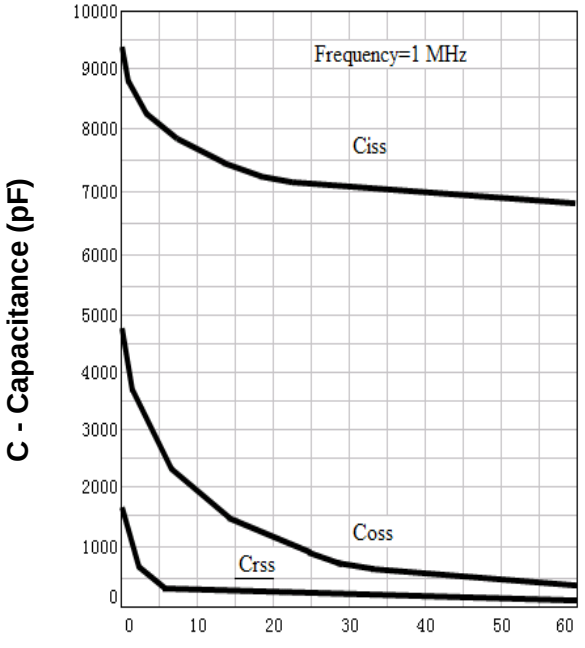
T_j - Junction Temperature (°C)

Source-Drain Diode Forward



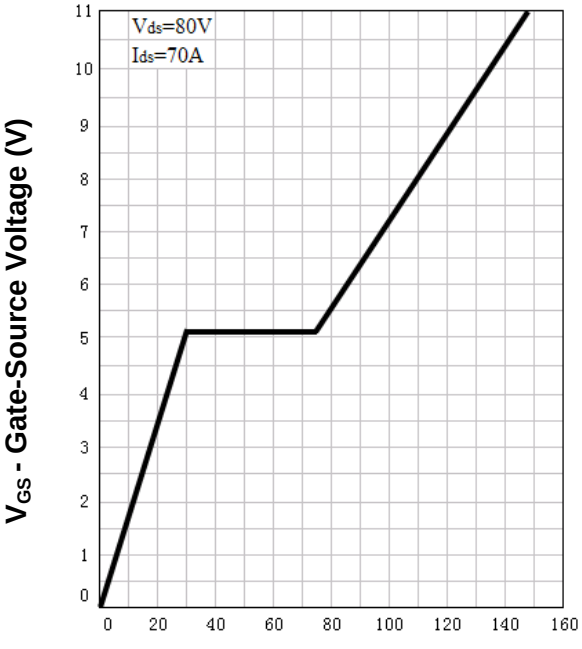
V_{SD} - Source-Drain Voltage (V)

Capacitance



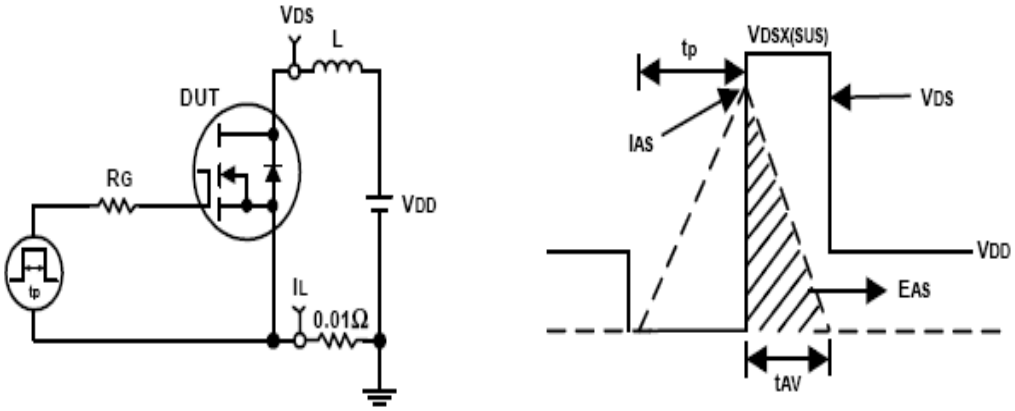
V_{DS} - Drain-Source Voltage (V)

Gate Charge

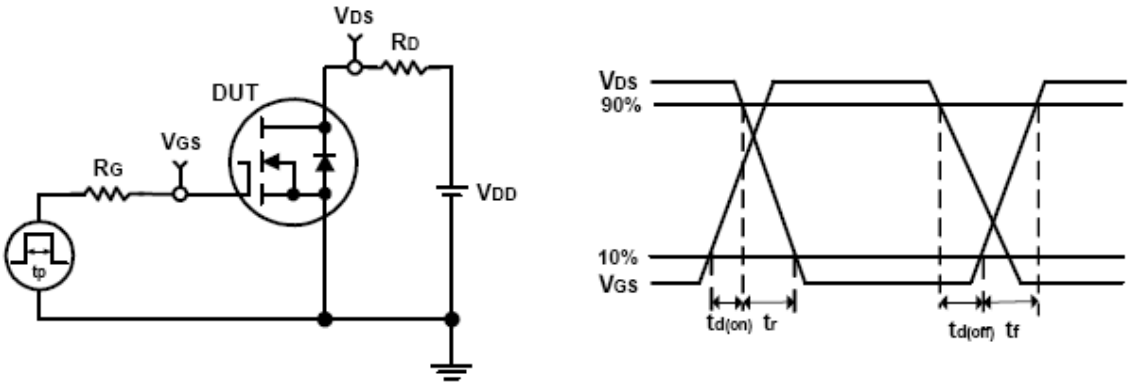


Q_G - Gate Charge (nC)

Avalanche Test Circuit and Waveforms



Switching Time Test Circuit and Waveforms

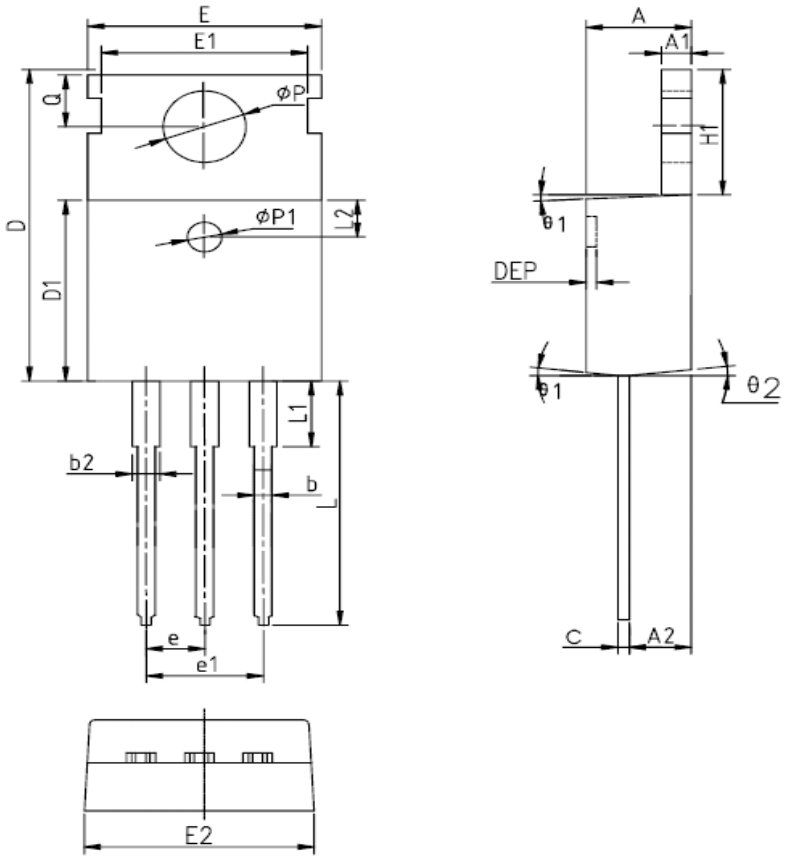


Ordering and Marking Information

Device	Marking	Package	Packaging	Quantity	Reel Size	Tape width
RU140N10R	RU140N10R	TO-220	Tube	50	-	-

Package Information

TO-220FB-3L



SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	4.40	4.57	4.70	0.173	0.180	0.185	Øp1	1.40	1.50	1.60	0.055	0.059	0.063
A1	1.27	1.30	1.33	0.050	0.051	0.052	e	2.54BSC			0.1BSC		
A2	2.35	2.40	2.50	0.093	0.094	0.098	e1	5.08BSC			0.2BSC		
b	0.77	-	0.90	0.030	-	0.035	H1	6.40	6.50	6.60	0.252	0.256	0.260
b2	1.23	-	1.36	0.048	-	0.054	L	12.75	-	13.17	0.502	-	0.519
C	0.48	0.50	0.52	0.019	0.020	0.021	L1	-	-	3.95	-	-	0.156
D	15.40	15.60	15.80	0.606	0.614	0.622	L2	2.50REF.			0.098REF.		
D1	9.00	9.10	9.20	0.354	0.358	0.362	Øp	3.57	3.60	3.63	0.141	0.142	0.143
DEP	0.05	0.10	0.20	0.002	0.004	0.008	Q	2.73	2.80	2.87	0.107	0.110	0.113
E	9.70	9.90	10.10	0.382	0.389	0.398	θ1	5°	7°	9°	5°	7°	9°
E1	-	8.70	-	-	0.343	-	θ2	1°	3°	5°	1°	3°	5°
E2	9.80	10.00	10.20	0.386	0.394	0.401							

ALL DIMENSIONS REFER TO JEDEC STANDARD
DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS

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